SHARP

То;	SPEC. No. LH21301 ISSUE: Mar. 25, 2021
SPEC	IFICATIONS
Product Name	Laser diode
Model No.	GH04C01B2G
	tain <u>10 pages including the cover and appendix.</u> as, please contact us before issuing purchasing order.
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Product Type	Laser diode
Model No.	GH04C01B2G
1. These specification sheets inclu	de materials protected under copyright of Sharp Corporation ("Sharp").

Please handle with great cares and do not reproduce or cause anyone to reproduce them without Sharp's consent.

2. When using this Sharp product, please observe the absolute maximum ratings, other conditions and instructions for use described in the specification sheets, as well as the precautions mentioned below. Sharp assumes no responsibility for any damages resulting from use of the product which does not comply with absolute maximum ratings, other conditions and instructions for use included in the specification sheets, and the precautions mentioned below.

(Precautions)

- (1) In making catalogue or instruction manual based on the specification sheets, please verify the validity of the catalogue or instruction manuals after assembling Sharp products in customer's products at the responsibility of customer.
- (2) This Sharp product is designed for use in the following application areas ;
 - Computers OA equipment Telecommunication equipment (Terminal) Measuring equipment
 - Tooling machines Audio visual equipment Home appliances

If the use of the Sharp product in the above application areas is for equipment listed in paragraphs (3) or (4), please be sure to observe the precautions given in those respective paragraphs.

- (3) Appropriate measures, such as fail-safe design and redundant design considering the safety design of the overall system and equipment, should be taken to ensure reliability and safety when Sharp product is used for equipment in responsibility of customer which demands high reliability and safety in function and precision, such as ;
 - Transportation control and safety equipment (aircraft, train, automobile etc.)
 - Traffic signals Gas leakage sensor breakers Rescue and security equipment
 - Other safety equipment
- (4)Sharp product is designed for consumer goods and controlled as consumer goods in production and quality. Please do not use this product for equipment which require extremely high reliability and safety in function and precision, such as ;
 - Space equipment Telecommunication equipment (for trunk lines)
 - Nuclear power control equipment
 Medical equipment
- (5) Please contact and consult with a Sharp sales representative if there are any question regarding interpretation of the above four paragraphs.
- 3. Disclaimer

The warranty period for Sharp product is one (1) year (or six (6) months in case of generalized product) after shipment. During the period, if there are any products problem, Sharp will repair (if applicable), replace or refund. Except the above, both parties will discuss to cope with the problems.

The failed Sharp product after the above one (1) year (or six (6) month for generalized product) period will be coped with by Sharp, provided that both parties shall discuss and determine on sharing responsibility based on the analysis results thereof subject to the above scope of warranty.

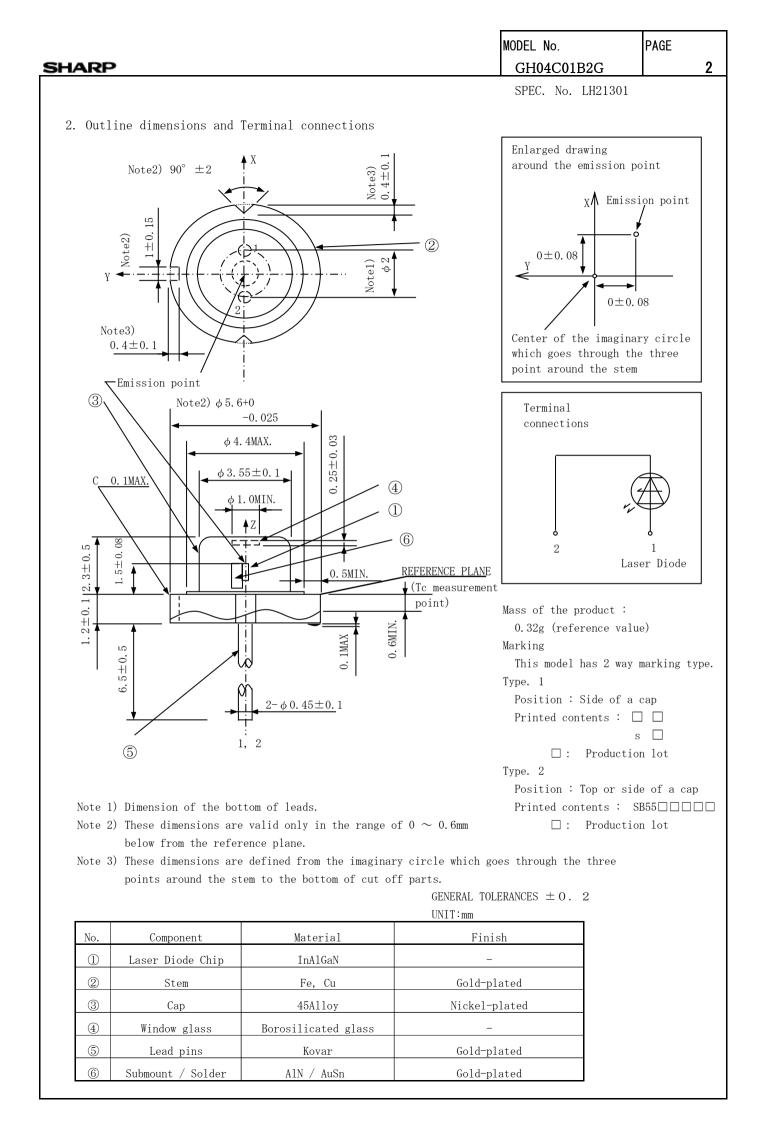
The warranty described herein is only for Sharp product itself which are purchased by or delivered to customer. Damages arising from Sharp product malfunction or failure shall be excepted.

Sharp will not be responsible for the Sharp product due to the malfunction or failures thereof which are caused by:

- (1) storage keep trouble during the inventory in the marketing channel.
- (2) intentional act, negligence or wrong/poor handling.
- (3) equipment which Sharp products are connected to or mounted in.
- (4) disassembling, reforming or changing Sharp products.
- (5) installation problem.
- (6) act of God or other disaster (natural disaster, fire, flood, etc.)
- (7) external factors (abnormal voltage, abnormal electromagnetic wave, fire, etc.)
- (8) special environment (factory, coastal areas, hotspring area, etc.)
- (9) phenomenon which cannot be foreseen based on the practical technologies at the time of shipment.
- (10) the factors not included in the product specification sheet.

4. Please contact and consult with a Sharp sales representative for any questions about Sharp product.

		MODEL No.	PAGE
SHARP		GH04C01B2G	1
		SPEC. No. LH21301	-
1. Scope			
This specification covers the appearance and characte	eristics of blue Lase	er Diode,	
Model No. GH04C01B2G			
[Outline of this product]			
This product is equipped with an InGaN multiple quant	um well blue laser o	liode .	
Oscillating transverse mode of this model is TE.			
Oscillating transverse mode of this model is multi-mo	ode.		
2. Outline Dimensions and Terminal Connections	described in page	2	
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				MODEL No.		P	AGE
HARP				GH04C	01B2G		
					lo. LH21	.301	
3. Ratings and Characteristics							
3-1 Absolute Maximum Ratings			(Tc=25°C	(Note 1))			
Parameter			Symbol	Va	alue	Uni	t
Optical power output (CW)			Ро		2	W	
Reverse voltage Lase	er diode		Vrl		2	V	
Operating temperature (Case temperature)			Top(c)	-10	\sim +50	°C)
Storage temperature			Tstg	-40	\sim +85	°C	<u>)</u>
Soldering temperature (Note 2)			Tsld		350	°C)
(Note 1) Tc : Case temperature (Tc measureme	ent point is	refer to	P2 draw	ving.)			
(Note 2) Soldering temperature means soldering	ng iron tip t	emperatu	re while	e soldering	g.		
3-2 Electro-optical Characteristics (Note 1)		(T	c=25°C)				
Parameter	Svmbol		itions	Min.	Тур.	Max.	Unit
Threshold current	Ith		-		0. 11	0.21	A
Operating current	Iop			_	1.1	1.4	A
Operating voltage	Vop			_	4.1	5.6	V
Wavelength	λρ			440	450	460	nm
Half Intensity Angle(Parallel)(Note 2,3)	$\theta \parallel$	Po=	1.8W	-	7	-	0
Half Intensity Angle (Perpendicular) (Note 2, 3)				22	26	30	0
Misalignment angle (Parallel) (Note 3)	$\Delta \theta \parallel$			-5	0	5	0
Misalignment angle (Perpendicular) (Note 3)	$\Delta \theta \perp$			-5	0	5	0
(Note 1) Initial value, Continuous Wave (0	Ŭ	Ū	
<pre>(Note 2) Angle of 50% peak intensity (Ful (Note 3) Parallel to the junction plane() Perpendicular to the junction plane</pre>	X-Z plane).						

MODEL No.

PAGE

4

GH04C01B2G SPEC. No. LH21301

SHARP

4. Reliability	
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	he reliability of pr	oducts satisfy all the items listed below.		Con	fidence le	vel : 90%
No.	Test	Test Conditions	Samples∶n	Defective:C	LTPD (%)	Failure criteria No. [4-2]
1	Solderability	Soldering temperature: 240±5℃(Flux used) Immersion time:5±0.5s	11	0	20	1
2	Resistance to soldering	Soldering iron tip temperature: 350±5℃ Immersion time:3±1s(Note 1)	11	0	20	3, 4, 5
3	Terminal strength (Tensile test)	Load:5N Duration:5±1s Once for each terminal	11	0	20	2
4	Terminal strength (Bending test)	Load:2.5N $0^{\circ} \sim 90^{\circ} \sim 0^{\circ} \sim -90^{\circ} \sim 0^{\circ}$ Once for each terminal	11	0	20	2
5	Mechanical shock	Acceleration:1000m/s ² Pulse width:6ms Direction: $\pm X$, $\pm Y$ and $\pm Z$ Three times for each direction	11	0	20	3, 4, 5
6	Variable frequency vibration	Acceleration:100m/s ² or Amplitude:1.5mm Frequency: 10~500~10Hz 15min reciprocation Direction: X,Y and Z 2 h for each direction	11	0	20	3, 4, 5
7	Temperature cycling	Lower temperature:-40°C Higher temperature:+85°C Duration:30min each, 30 times	11	0	20	3, 4, 5
8	High temperature storage	Storage temperature:85°C t=500 h	11	0	20	3, 4, 5
9	Low temperature storage	Storage temperature:-40°C t=500 h	11	0	20	3, 4, 5

(Note 1)Soldering position is $1.\,0\mathrm{mm}$ apart from bottom edge of the case.

(Note 2)To be measured after 72 hours exposure to the room atmosphere.

(Note 3) These test results are sampling examples from a specific lot for reference purpose only,

and do not constitute any warranty or assurance in connection with the devices.

4-2 Parameters to be measured and Failure criteria

No.	Parameters	Failure judgment criteria
1	1 Solderability 95% or more is covered with solder.	
2	Terminal strength	It is defective if there are breaking and loosening.
3	Threshold current	Ith > initial value $\times 1.3$, Ith < initial value $\times 0.7$
4	Operating current	Iop $>$ initial value $\times 1.3$, Iop $<$ initial value $\times 0.7$
5	Operating voltage	Vop $>$ initial value $\times 1.2$, Vop $<$ initial value $\times 0.8$

4-3 Lifetime Test

The target mean time to failure (MTTF) of this product is more than 2,000 h. MTTF is confirmed by performing the operating test under the following conditions in time of development or change process related to the reliability of this product.

Samples tested should have a laser diode chip with the same structure of this model.

Conditions	Failure judgment criteria
Тс=50°С,	Failure is defined as the time under the output power under the conditions
Po=1.8W (init),	in the left changes -50% of the initial (12 h) value(Note 1). As for the
500 hours	samples which do not fail within 500 hours, their life time is calculated
(Note 2)	by extrapolating operating power data of between 400 and 500 hours.
	MTTF is estimated by plotting each life time in Weibull function worksheet. (Note 1)

(Note 1) Defective samples caused by surge current is rejected.

(Note 2) ACC Operation

(Note 3) These test results are sampling examples from a specific lot for reference purpose only, and do not constitute any warranty or assurance in connection with the devices.

				MODEL No.	. P/	AGE
IARP				GH04C	C01B2G	
				SPEC. N	No. LH21301	
Quality level						
Inspection standar	rds ISO 28	59 single sample	ing plan			
Inspection level	S-2 no	rmal inspection				
AQL						
-1 Definition of th	ne lot the da	y shipping the p	product			
-2 Characteristics				1		
QL (%)		meter		Failure ju	dgment criteria	
	op, ηd, λ p, θ		$\Delta \theta \perp$	Not conforming to	the specificatio	ons
tel) Inspection is	performed after	blowing.				
-3 Appearance						
	ment criteria					
	ound on the wir	-				
	not sufficiently					
	n not be restore					
			$50\mu\mathrm{m}$ is found	within $1 \text{mm} \phi$ to the second sec	he center of	
	of the window gl					
	stem is not conf		ification			
te2) Inspection is	performed after	blowing.				
5-2 RoHS compliant p This product compl Commission Delegat 5-3 Information rela Product Informatio by Electronic Info	ies with EU RoHS ced Directive (EU ating to China Ro on Notification b)2015/863. HS. ased on Chinese		nt Methods for Con	trolling Pollutio	on
Names and Contents	s of the Toxic an	d Hazardous Subs	stances or Elem	ments in the Produ	ct	1
Lead (Pb)	Mercury (Hg)	Cadmium (Cd)	Hexavalent Chromium (Cr(VI))	Polybrominated Biphenyls (PBB)	Polybrominated Diphenyl Ethers (PBDE)	
0	0	0	0	0	0	
This table was o	created pursuant	to the provision	ns of SJ / T 11	1364.		
○ : indicates	that the content of the part is b	of the toxic a	nd hazardous su	ubstance in all the requirement as desc	0	
homogeneou		e part exceeds t		ubstance in at lea ion limit requirem		

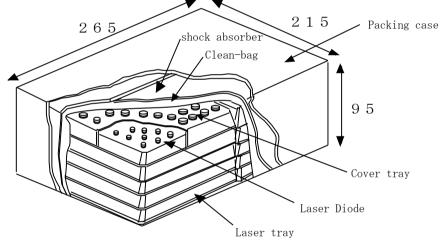
	MODEL No.	PAGE
HARP	GH04C01B2G	
	SPEC. No. LH21301	
6-4. Packing (Type 1)		
Note) This model has 2 way packing type. This packing method is app	lied to GH04C01B2G0E made in	Taiwan.
6-4-1. Packing method		
(1) Laser diodes are arranged in a laser tray.		
(2) One tray can accommodate 200 lasers. 5 trays wherein the laser	diodes are arranged are stac	ked up.
(3) A cover tray is stacked as a cover on the tray wherein the lase	r diodes are arranged. Stack	ed trays
including a cover are bound with adhesive tape.		
(4) The shows have a staffed into a show here. The here is	1	1

- (4) The above bound trays are stuffed into a clean-bag. The bag is sealed by dissolving thermally.
- (5) The trays in the bag are put into a packing case. One packing case can accommodate 2,000 lasers maximum, which is the minimum unit of packing. A Label where in the model number, quantity and lot number are printed is stuck on both of the bag and the case (Refer to 6-4-4).

6-4-2. Materials for packing

No.	Component parts	Material
1	Laser tray	conductive polystyrene resin
2	Cover tray	conductive polystyrene resin
3	Clean-bag	anti–static plastic
4	Packing case	cardboard
5	shock absorber	anti–static polyetyrene

6-4-3. External appearance of packing



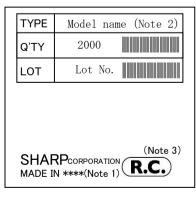
UNIT:mm

6-4-4. Label
(1)A label on the clean-bag

TYPE	Model name (Note 2)
Q'TY	1000
LOT	Lot No.
SHAF MADE I	(Note 3) N ****(Note 1)

(Note 1) ********:Production country

(2)A label on the packing case



(Note 3) This identification mark shows the settlement product for RoHS designed by using a green material based on our green device guideline.

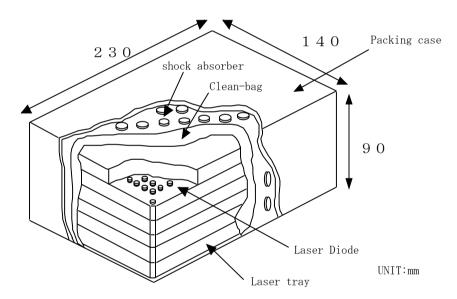
	MODEL No.	PAGE
SHARP	GH04C01B2G	7
	SPEC. No. LH21301	
6-5. Packing (Type 2)		
Note) This model has 2 way packing type. This packing method i	s applied to GH04C01B2G07 made in I	ndonesia.

- 6-5-1. Packing method (1) Laser diodes are arranged in a laser tray.
- (2) One tray can accommodate 200 lasers. 5 trays wherein the laser diodes are arranged are stacked up.
- (3) A cover tray is stacked as a cover on the tray wherein the laser diodes are arranged. Stacked trays including a cover are bound with adhesive tape.
- (4) The above bound trays are stuffed into a clean-bag. The bag is sealed by dissolving thermally.
- (5) The trays in the bag are put into a packing case. One packing case can accommodate 2,000 lasers maximum, which is the minimum unit of packing. A Label where in the model number , quantity and lot number are printed is stuck on both of the bag and the case(Refer to 6-4-4).

6-5-2. Materials for packing

No.	Component parts	Material
1	Laser tray	conductive polystyrene resin
2	Clean-bag	anti–static plastic
3	Packing case	cardboard
4	shock absorber	anti–static polyetyrene

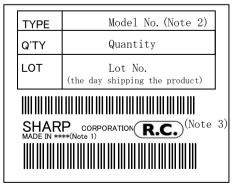
6-5-3. External appearance of packing



6-5-4. Label (1)A label on the clean-bag



(2) A label on the packing case



(Note 1) ********:Production country

(Note 2) A management number in the factory is written in (), if the product produced in a factory except Japan.

(Note 3) This identification mark shows the settlement product for RoHS designed by using a green material based on our green device guideline.

	MODEL No.	PAGE	
HARP	GH04C01B2G		
Operating and handling presentions	SPEC. No. LH2130	1	
 Operating and handling precautions This product has its life. The product life which is describing into account when using it. 	bed in "Reliability" should be t	aken	
(2) This product will be damaged by electrostatic discharge(ESD), to avoid ESD damage.). Following precautions should	be taken	
⇒ Workers, workbenches and other equipment should always be an antistatic wrist strap and an antistatic smock on the		's wear	
⇒ When handling this product, workers should always wear an ⇒ A stable DC power supply which is free from electrical the operating this product. A slow starter circuit should always supply and this product in order to protect it from DC mathematical states.	ransients should always be used ways be inserted between the pow	when	
supply and this product in order to protect it from DC po ⇒ Optical power output of this product should be set with a variable resistance.		ty	
⇒ This product should always be connected to the driving consistent highly reliable connectors.	ircuit by soldering directly or	through	
⇒ While this product is being operated, be sure to avoid to terminals of this product with electrical probes from a	synchroscope or a voltmeter.	he	
⇒ An antistatic package should be used when storing this package. The recommended preservation is stored in the tray and the in an environmental condition dry at normal temperature ()	e clean-bag		
 ⇒ This product should be processed in the rooms where relat (3) This product doesn't do the design that intends use in the : 	tive humidity is kept at 50-70%R	εH.	
Please use it after confirming the performance and reliabil: before use in the following special environment.			
 ⇒Use in place where a lot of moisture, be dewys, sea breeze NH3, SO2, and NOX, etc.) exist. ⇒Use under direct sunshine, in out-of-door exposure, or in 		,	
⇒Use in atmosphere such as water, oil, drug solutions, or o			
\Rightarrow Use in environment with strong static electricity or elect	tromagnetic radiation.		
⇒Use in state installed near generation of heat parts or in near this product.	n state to arrange combustible		
(4) Because the adhesion of garbage and dust to the window glass characteristic of this product, maintain the work room to c			
generate dust, please.(5) In this Product, generation of heat happens in the laser chip The case temperature rises by this generation of heat. Becau			
the case temperature becomes a factor to shorten the lifetin			
a sufficient heat sink should be attached to this product wh	hen operating so that its case		
temperature is to be maintained at the same level as that of			
(6) Even if the drive current supply has an automatic power con			
automatic current control (ACC), or both, be sure to monitor with an optical power meter while setting it. Never estimate			
only from the drive current because it is likely to be decre of the surrounding.			
(7) When dirt adheres to the window glass of this product, pleas the cotton bud that adheres the ethanol.	se wipe lightly with		
(8) This product consists of a hermetic package, in which the b	*		
mounted. The blue laser diode chip will be easily damaged by So when the package does not keep hermetically, the lifetime remarkably shorten.			
Following precautions should be taken to avoid destroying th ⇒The window glass cracks easily because it is thin.	he hermetic package.		
Please do not give an impact to the window glass by dropp: Please avoid applying the stress to the cap, for example of			
or fixing to the treatment device. ⇒Because applying the overstress to the lead pin or repeat its bottom, will destroy the hermetic seal. Please do not a			
base part of lead pin. ⇒When a large stress is applied to the package, please conf kept hermetically before using this product.	firm whether the package is		
(9) Since laser beam from this product will be harmful to the hu should be taken.			
 ⇒ When this product is being operated, the emitting surface directly or through a lens, microscope or optical fibers. ⇒ When operating this product, wear safety glasses. 		l either	
 (10) When soldering this product, heat lead pins only using a solar Avoid heat the whole package using pre-heat or reflow sold 			